



INITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

Heung-Kyu KWON et al.

Serial No.:

09/464,322

Group: 2815

Filed:

December 15, 1999

Examiner: Chris C. Chu

For:

SEMICONDUCTOR CHIP PACKAGE AND METHOD OF FABRICATING

THE SAME

## **RULE 116 AMENDMENT**

Honorable Commissioner for Patents Washington, D.C. 20231

February 19, 2003

Dear Sir:

Responsive to the final Office Action dated November 19, 2002 please enter the following amendments and comments.

